## **Declaration, Power of Attorney and Petition**

Page 1 of 3

WE (I) the undersigned inventor(s), hereby declare(s) that:

My residence, post office address and citizenship are as stated below next to my name,

We (I) believe that we are (I am) the original, first and joint (sole) inventor(s) of the subject matter which is claimed and for which a patent is sought on the invention entitled

	•	is sought on the invention end	ntled DRDING/REPRODUCING MET	THOD			
the specification of							
	is attached he	ereto.					
	was filed on as						
	Application S	Serial No.					
	and amended	on	<u> </u>				
		PCT international application					
	Number						
	on		,				
	and was ame	nded under PCT Article 19					
	on	(if appli	cable).				
including the clai	ms, as amende	ed by any amendment referred					
		ty to disclose information known the 37 Code of Federal Regulation.	own to be material to the patenta ations.	ability of	this a	pplica	ition
application(s) for at least one coun any foreign appl	patent or invetry other than ication for pa	entor's certificate, or § 365(a) the United States, listed belo	35 U.S.C. § 119(a)-(d) or § ) of any PCT International application and have also identified below, or PCT International application Foreign Application (s)	ication wow, by ch	hich d ecking	lesign g the	ated box,
Application	No.	Country	Day/Month/Year			rity med	
2002-2649	73	Japan	11/September/2002	$\boxtimes$	Yes		No
	<u> </u>				Yes		No
					Yes		No
					Yes		No

We (I) hereby claim the benefit under Title 35, Unite application(s) listed below.	d States Code, § 119(e) of any United States provisional						
(Application Number)	(Filing Date)						
(Application Number)	(Filing Date)						
We (I) hereby claim the benefit under 35 U.S.C. § 120 of any United States application(s), or under § 365(c) of any PCT International application designating the United States, listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States or PCT International application in the manner provided by the first paragraph of 35 U.S.C. § 112, I acknowledge the duty to disclose information which is material to patentability as defined in 37 CFR § 1.56 which became available between the filing date of the prior application and the national or PCT International filing date of this application.							
Application Serial No. Filing D	ate Status (pending, patented, abandoned)						
And we (I) hereby appoint the following registered practitioner(s):							
22850							
as our (my) attorneys, with full powers of substitution and revocation, to prosecute this application and to transact all business in the Patent Office connected therewith; and we (I) hereby request that all correspondence regarding this application be sent to							
22850							
We (I) declare that all statements made herein of our (my) own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.							
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	Citizen of:
Signature of Inventor	Mailing Address:
Date	